



# ±15 kV ESD Protected, 3.3 V, RS-232 Line Driver/Receiver

## ADM3232E

### FEATURES

Data rate: 460 kbps  
2 Tx and 2 Rx  
Meets EIA-232E specifications  
0.1  $\mu$ F charge pump capacitors  
ESD protection to IEC 1000-4-2 (801.2) on RS-232 I/Os  
Contact discharge:  $\pm 8$  kV  
Air gap discharge:  $\pm 15$  kV

### APPLICATIONS

General-purpose RS-232 data link  
Portable instruments  
Handsets  
Industrial/telecom diagnostic ports

### GENERAL DESCRIPTION

The ADM3232E transceiver is a high speed, 2-channel RS-232/V.28 interface device that operates from a single 3.3 V power supply. Low power consumption makes it ideal for battery-powered portable instruments. The ADM3232E conforms to the EIA-232E and ITU-T V.28 specifications and operates at data rates up to 460 kbps.

All RS-232 ( $T_{XOUT}$  and  $R_{XIN}$ ) inputs and outputs are protected against electrostatic discharges (up to  $\pm 15$  kV ESD protection). This ensures compliance with IEC 1000-4-2 requirements.

This device is ideally suited for operation in electrically harsh environments or where RS-232 cables are frequently plugged/unplugged, with the  $\pm 15$  kV ESD protection of the ADM3232E RS-232 input/output pins.

### FUNCTIONAL BLOCK DIAGRAM

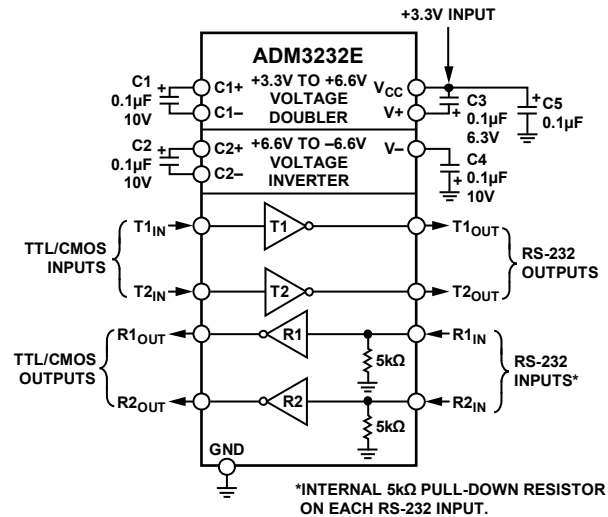


Figure 1.

Emissions are also controlled to within very strict limits. CMOS technology is used to keep the power dissipation to an absolute minimum, allowing maximum battery life in portable applications.

Four external 0.1  $\mu$ F charge pump capacitors are used for the voltage doubler/inverter, permitting operation from a single 3.3 V supply.

The ADM3232E is available in a 16-lead narrow and wide SOIC packages, as well as a space-saving 16-lead TSSOP.

#### Rev. B

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TABLE OF CONTENTS

|                                |   |                                                  |    |
|--------------------------------|---|--------------------------------------------------|----|
| Features .....                 | 1 | Pin Configuration and Function Descriptions..... | 5  |
| Applications.....              | 1 | Typical Performance Characteristics .....        | 6  |
| Functional Block Diagram ..... | 1 | Theory of Operation .....                        | 8  |
| General Description .....      | 1 | Circuit Description .....                        | 8  |
| Revision History .....         | 2 | High Baud Rate.....                              | 8  |
| Specifications.....            | 3 | Outline Dimensions .....                         | 9  |
| Absolute Maximum Ratings.....  | 4 | Ordering Guide .....                             | 10 |
| ESD Caution.....               | 4 |                                                  |    |

REVISION HISTORY

|                                                              |           |
|--------------------------------------------------------------|-----------|
| <b>4/11—Rev. A to Rev. B</b>                                 |           |
| Changes to Features Section and General Description          |           |
| Section .....                                                | 1         |
| Change to ESD Protection (RS-232 I/O Pins) Parameter,        |           |
| Table 1 .....                                                | 3         |
| Change to ESD Protection on RS-232 Pins Section Heading..... | 8         |
| <b>7/08—Rev. 0 to Rev. A</b>                                 |           |
| Added 16-Lead SOIC.....                                      | Universal |
| Updated Outline Dimensions .....                             | 9         |
| Changes to Ordering Guide .....                              | 10        |

12/06—Revision 0: Initial Version

## SPECIFICATIONS

$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $C1$  to  $C4 = 0.1 \text{ }\mu\text{F}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 1.

| Parameter                                    | Min                   | Typ  | Max | Unit | Test Conditions/Comments                                                                                                                    |
|----------------------------------------------|-----------------------|------|-----|------|---------------------------------------------------------------------------------------------------------------------------------------------|
| DC CHARACTERISTICS                           |                       |      |     |      |                                                                                                                                             |
| Operating Voltage Range                      | 3.0                   | 3.3  | 5.5 | V    | No load                                                                                                                                     |
| V <sub>CC</sub> Power Supply Current         |                       | 1.3  | 3   | mA   |                                                                                                                                             |
| LOGIC                                        |                       |      |     |      |                                                                                                                                             |
| Input Logic Threshold Low, V <sub>INL</sub>  | 2.0                   |      | 0.8 | V    | T <sub>IN</sub>                                                                                                                             |
| Input Logic Threshold High, V <sub>INH</sub> |                       |      |     | V    | T <sub>IN</sub>                                                                                                                             |
| TTL/CMOS Output Voltage Low, V <sub>OL</sub> | V <sub>CC</sub> – 0.6 |      | 0.4 | V    | I <sub>OUT</sub> = 1.6 mA                                                                                                                   |
| TTLCMOS Output Voltage High, V <sub>OH</sub> |                       |      |     | V    | I <sub>OUT</sub> = –1 mA                                                                                                                    |
| Logic Pull-Up Current                        |                       | 5    | 10  | μA   | T <sub>IN</sub> = GND to V <sub>CC</sub>                                                                                                    |
| Transmitter Input Hysteresis                 |                       | 0.5  |     | V    |                                                                                                                                             |
| RS-232 RECEIVER                              |                       |      |     |      |                                                                                                                                             |
| Input Voltage Range                          | –30                   |      | +30 | V    |                                                                                                                                             |
| Input Threshold Low                          | 0.6                   | 1.2  |     | V    |                                                                                                                                             |
| Input Threshold High                         |                       | 1.6  | 2.4 | V    |                                                                                                                                             |
| Input Hysteresis                             |                       | 0.4  |     | V    |                                                                                                                                             |
| Input Resistance                             | 3                     | 5    | 7   | kΩ   |                                                                                                                                             |
| RS-232 TRANSMITTER                           |                       |      |     |      |                                                                                                                                             |
| Output Voltage Swing (RS-232)                | ±5.0                  | ±5.2 |     | V    | V <sub>CC</sub> = 3.3 V, all transmitter outputs loaded with 3 kΩ to ground                                                                 |
| Output Voltage Swing (RS-562)                | ±3.7                  |      |     | V    | V <sub>CC</sub> = 3.0 V                                                                                                                     |
| Transmitter Output Resistance                | 300                   |      |     | Ω    | V <sub>CC</sub> = 0 V, V <sub>OUT</sub> = ±2 V                                                                                              |
| Output Short-Circuit Current (RS-232)        |                       | ±15  |     | mA   |                                                                                                                                             |
| TIMING CHARACTERISTICS                       |                       |      |     |      |                                                                                                                                             |
| Maximum Data Rate                            | 460                   |      |     | kbps | V <sub>CC</sub> = 3.3 V, R <sub>L</sub> = 3 kΩ to 7 kΩ, C <sub>L</sub> = 50 pF to 1000 pF, one Tx switching                                 |
| Receiver Propagation Delay                   |                       |      |     |      | R <sub>L</sub> = 3 kΩ, C <sub>L</sub> = 1000 pF                                                                                             |
| t <sub>PHL</sub>                             |                       | 0.4  | 1   | μs   |                                                                                                                                             |
| t <sub>PLH</sub>                             |                       | 0.4  | 1   | μs   |                                                                                                                                             |
| Transmitter Propagation Delay                |                       | 300  | 1.2 | μs   |                                                                                                                                             |
| Receiver Output Enable Time                  |                       | 200  |     | ns   |                                                                                                                                             |
| Receiver Output Disable Time                 |                       | 200  |     | ns   | Measured from +3 V to –3 V or –3 V to +3 V, V <sub>CC</sub> = 3.3 V; R <sub>L</sub> = 3 kΩ, C <sub>L</sub> = 1000 pF, T <sub>A</sub> = 25°C |
| Transmitter Skew                             |                       | 30   |     | ns   |                                                                                                                                             |
| Receiver Skew                                |                       | 300  |     | ns   |                                                                                                                                             |
| Transition Region Slew Rate                  | 5.5                   | 10   | 30  | V/μs |                                                                                                                                             |
| ESD PROTECTION (RS-232 I/O PINS)             |                       |      |     |      |                                                                                                                                             |
|                                              |                       | ±15  |     | kV   | Human body model                                                                                                                            |
|                                              |                       | ±15  |     | kV   | IEC 1000-4-2 air discharge                                                                                                                  |
|                                              |                       | ±8   |     | kV   | IEC 1000-4-2 contact discharge                                                                                                              |

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

**Table 2.**

| Parameter                                                   | Rating                                          |
|-------------------------------------------------------------|-------------------------------------------------|
| $V_{CC}$                                                    | $-0.3\text{ V to }+6\text{ V}$                  |
| $V_+$                                                       | $(V_{CC} - 0.3\text{ V})\text{ to }14\text{ V}$ |
| $V_-$                                                       | $+0.3\text{ V to }-14\text{ V}$                 |
| Input Voltages                                              |                                                 |
| $T_{XIN}$                                                   | $-0.3\text{ V to } (V_{CC} + 0.3\text{ V})$     |
| $R_{XIN}$                                                   | $\pm 30\text{ V}$                               |
| Output Voltages                                             |                                                 |
| $T_{XOUT}$                                                  | $\pm 15\text{ V}$                               |
| $R_{XOUT}$                                                  | $-0.3\text{ V to } (V_{CC} + 0.3\text{ V})$     |
| Short-Circuit Duration                                      |                                                 |
| $T_{XOUT}$                                                  | Continuous                                      |
| Power Dissipation R-16/RW-16<br>(Derate 6 mW/°C Above 50°C) | 450 mW                                          |
| $\theta_{JA}$ , Thermal Impedance                           | 158°C/W                                         |
| Power Dissipation RU-16<br>(Derate 6 mW/°C Above 50°C)      | 500 mW                                          |
| $\theta_{JA}$ , Thermal Impedance                           | 158°C/W                                         |
| Operating Temperature Range                                 |                                                 |
| Industrial (A Version)                                      | $-40^\circ\text{C to }+85^\circ\text{C}$        |
| Storage Temperature Range                                   | $-65^\circ\text{C to }+150^\circ\text{C}$       |
| Lead Temperature<br>(Soldering, 10 sec)                     | JEDEC industry-standard<br>J-STD-020            |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

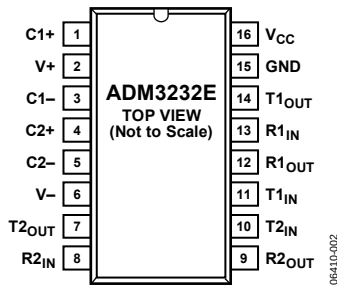


Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

| Pin No. | Mnemonic     | Description                                                                                                                                          |
|---------|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1, 3    | C1+, C1-     | External Capacitor 1 is connected between these pins. A 0.1 $\mu$ F capacitor is recommended, but larger capacitors of up to 47 $\mu$ F can be used. |
| 2       | V+           | Internally Generated Positive Supply (6 V Nominal).                                                                                                  |
| 4, 5    | C2+, C2-     | External Capacitor 2 is connected between these pins. A 0.1 $\mu$ F capacitor is recommended, but larger capacitors of up to 47 $\mu$ F can be used. |
| 6       | V-           | Internally Generated Negative Supply ( $-6$ V Nominal).                                                                                              |
| 7, 14   | T2OUT, T1OUT | Transmitter (Driver) Outputs. These are RS-232 signal levels (typically $\pm 6$ V).                                                                  |
| 8, 13   | R2IN, R1IN   | Receiver Inputs. These inputs accept RS-232 signal levels. An internal 5 k $\Omega$ pull-down resistor to GND is connected on each input.            |
| 9, 12   | R2OUT, R1OUT | Receiver Outputs. These are TTL/CMOS output logic levels.                                                                                            |
| 10, 11  | T2IN, T1IN   | Transmitter (Driver) Inputs. These inputs accept TTL/CMOS levels.                                                                                    |
| 15      | GND          | Ground Pin. Must be connected to 0 V.                                                                                                                |
| 16      | VCC          | Power Supply Input (3.3 V $\pm$ 0.3 V).                                                                                                              |

## TYPICAL PERFORMANCE CHARACTERISTICS

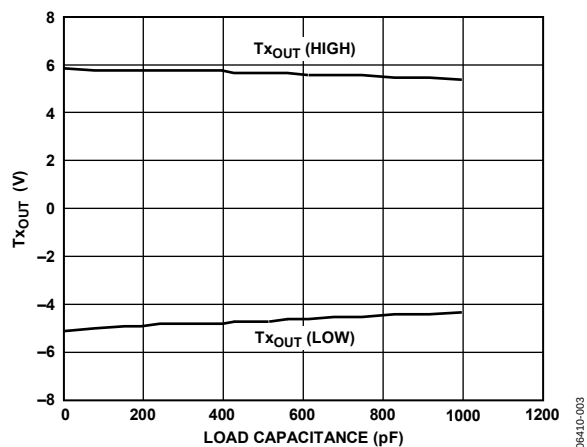


Figure 3. Transmitter Output Voltage High/Low vs. Load Capacitance @ 460 kbps

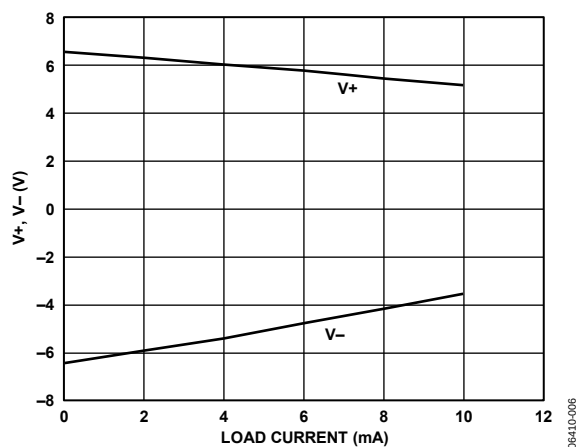


Figure 6. Charge Pump V+, V- vs. Load Current

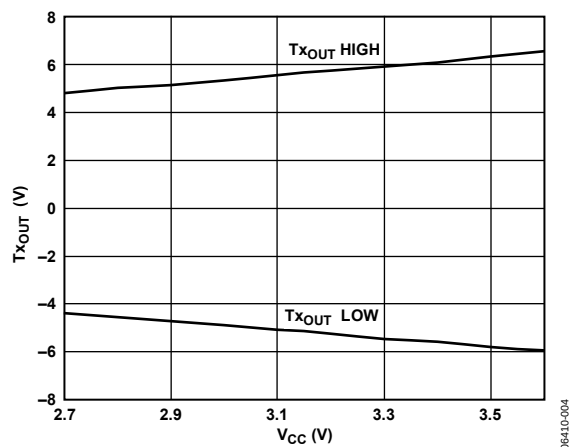


Figure 4. Transmitter Output Voltage vs. VCC

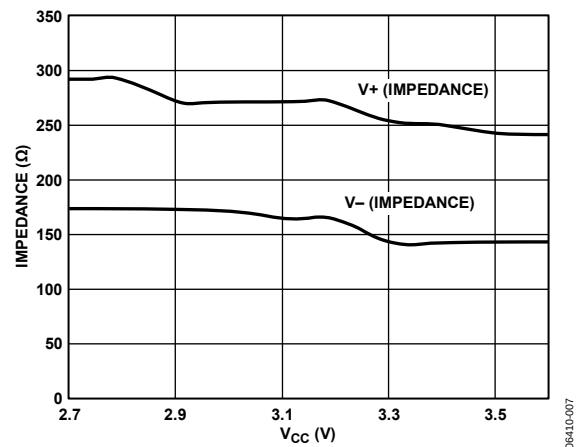


Figure 7. Charge Pump Impedance vs. VCC

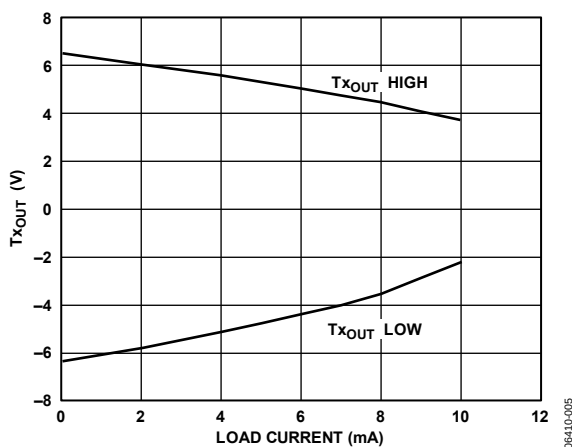


Figure 5. Transmitter Output Voltage High/Low vs. Load Current

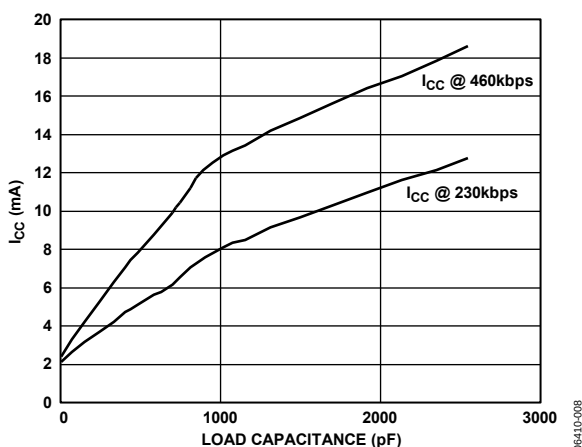


Figure 8. Power Supply Current vs. Load Capacitance

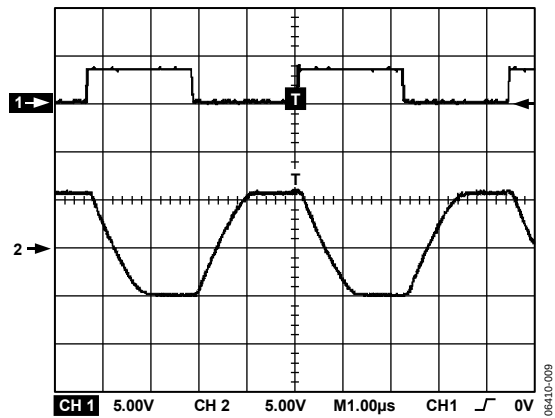
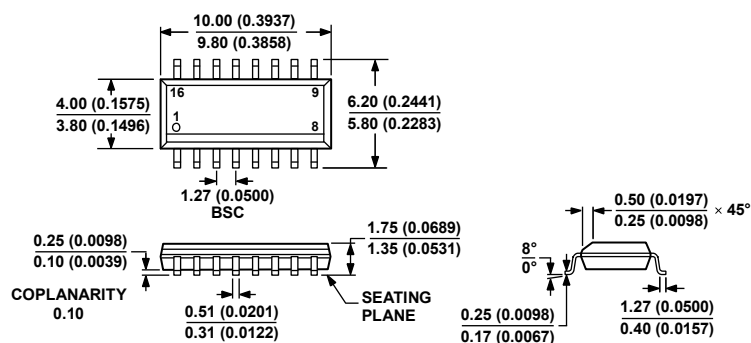


Figure 9. 460 kbps Data Transmission





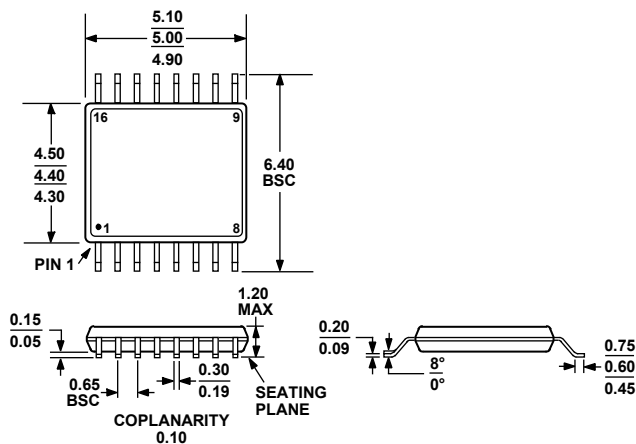
## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AC  
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS  
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR  
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 13. 16-Lead Standard Small Outline Package [SOIC\_N]  
Narrow Body  
(R-16)

Dimensions shown in millimeters (and inches)

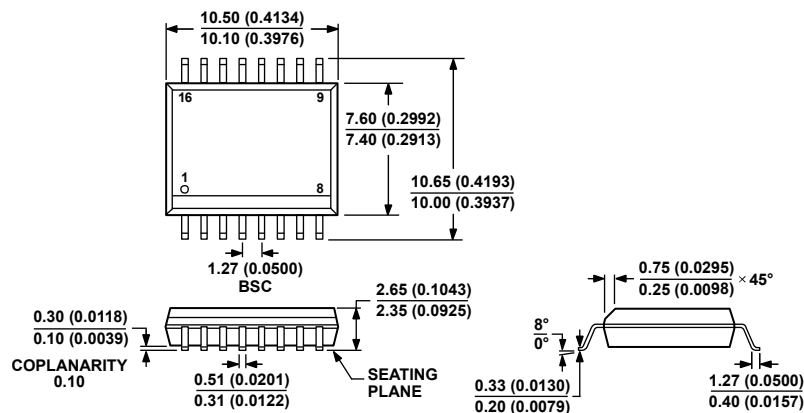


COMPLIANT TO JEDEC STANDARDS MO-153-AB

Figure 14. 16-Lead Thin Shrink Small Outline Package [TSSOP]  
(RU-16)

Dimensions shown in millimeters

# ADM3232E



COMPLIANT TO JEDEC STANDARDS MS-013-AA  
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS  
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR  
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 15. 16-Lead Standard Small Outline Package [SOIC\_W]  
Wide Body  
(RW-16)

Dimensions shown in millimeters (and inches)

03-27-2007-B

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description | Package Option |
|--------------------|-------------------|---------------------|----------------|
| ADM3232EARNZ       | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADM3232EARNZ-REEL7 | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADM3232EARUZ       | −40°C to +85°C    | 16-Lead TSSOP       | RU-16          |
| ADM3232EARUZ-REEL7 | −40°C to +85°C    | 16-Lead TSSOP       | RU-16          |
| ADM3232EARWZ       | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADM3232EARWZ-REEL  | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |

<sup>1</sup> Z = RoHS Compliant Part.

NOTES

**ADM3232E**

## **NOTES**